### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE3065G uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

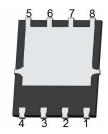
100% UIS TESTED! 100% ΔVds TESTED!

#### **General Features**

- $V_{DS} = 30V, I_{D} = 65A$ 
  - $R_{DS(ON)}$ =5.7m $\Omega$  (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =7.7m $\Omega$  (typical) @  $V_{GS}$ =4.5V
- High density cell design for ultra low Rdson
- Very low on-resistance R<sub>DS(on)</sub>
- Good stability and uniformity with high E<sub>AS</sub>
- 150 °C operating temperature
- Pb-free lead plating

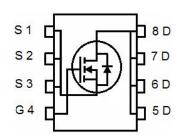
#### **DFN 5X6**





**Top View** 

**Bottom View** 



**Schematic Diagram** 

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3065G	NCE3065G	DFN 5x6-8L	-	-	-

### Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	65	А
Drain Current-Continuous(T <sub>C</sub> =100 ℃)	I <sub>D</sub> (100℃)	46	А
Pulsed Drain Current <sup>(Note 1)</sup>	I <sub>DM</sub>	200	А
Maximum Power Dissipation	P <sub>D</sub>	65	W
Derating factor		0.52	W/°C
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	150	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	Rejc	1.92	°C/W



## Electrical Characteristics (TC=25°Cunless otherwise noted)

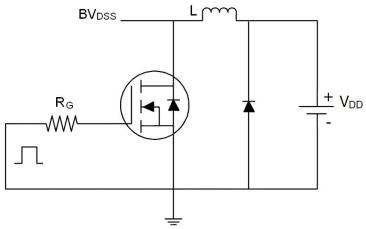
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics		,	- 1			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)		,	1			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	1	1.5	2.5	V
Drain Course On State Besistense	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	5.7	7.0	0
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	7.7	9.5	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	20	-	-	S
Dynamic Characteristics (Note4)			1			
Input Capacitance	Clss	45)()( 0)(	-	1400	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V,	-	205	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	177	-	PF
Switching Characteristics (Note 4)	,		•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =15V,I <sub>D</sub> =20A	-	8	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =6 $\Omega$	-	28	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS
Total Gate Charge	Qg	)/ 45\/\ 00A	-	32.3	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>D</sub> =20A,	-	4.9	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	6.9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	65	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, I <sub>F</sub> = 20A	-	-	27	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs <sup>(Note3)</sup>	-	-	20	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD			y LS+LD)	

#### Notes:

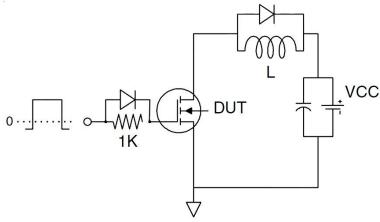
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

## **Test Circuit**

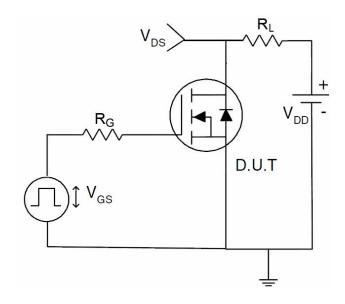
## 1) E<sub>AS</sub> Test Circuits



## 2) Gate Charge Test Circuit

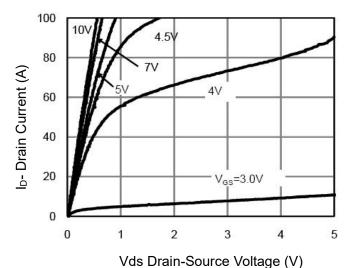


## 3) Switch Time Test Circuit

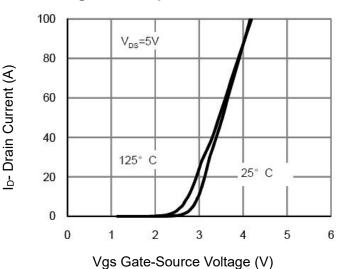




## **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

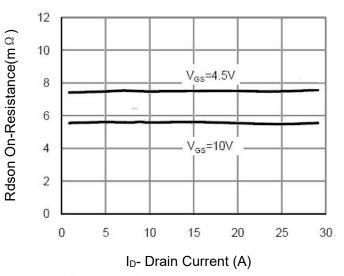


Figure 3 Rdson- Drain Current

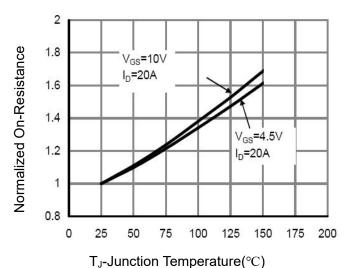


Figure 4 Rdson-JunctionTemperature

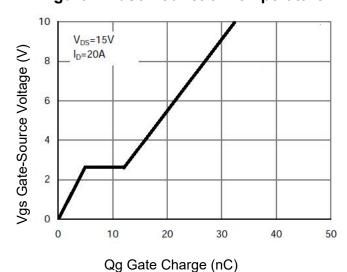


Figure 5 Gate Charge

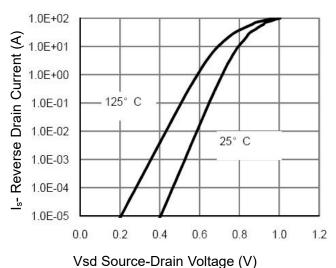


Figure 6 Source- Drain Diode Forward



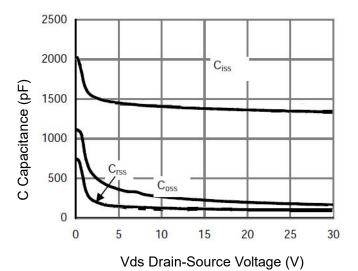


Figure 7 Capacitance vs Vds

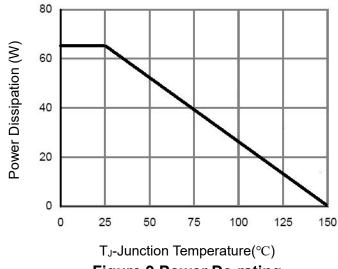


Figure 9 Power De-rating

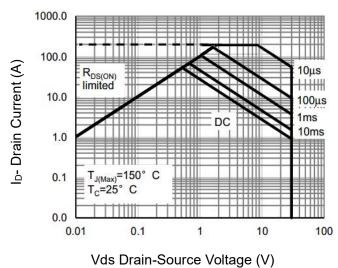


Figure 8 Safe Operation Area

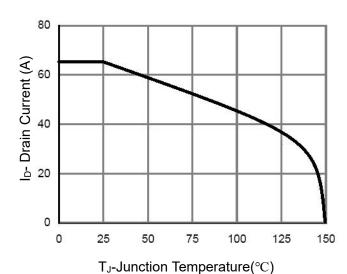
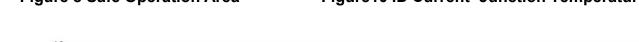
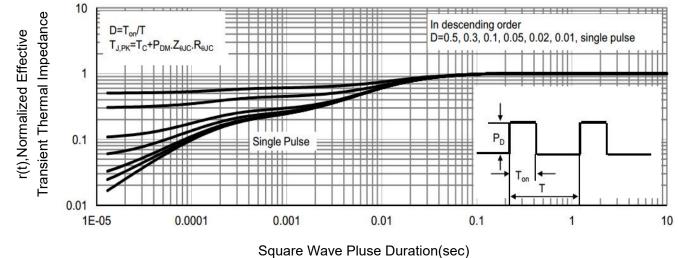


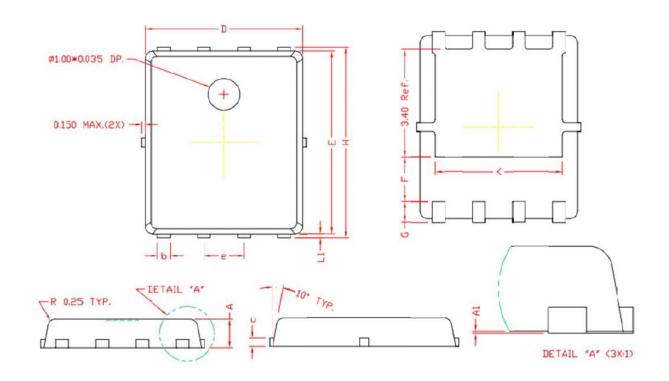
Figure 10 ID Current- Junction Temperature





**Figure 11 Normalized Maximum Transient Thermal Impedance** 

## **DFN5X6-8L Package Information**



## COMMON DIMENSIONS

# (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
A	0.80	0.90	1.00		
A1	0.00	0.03	0.05		
b	0.35	0.42	0.49		
c	0	. 254 REF	₹.		
D	4.90	5.00	5. 10		
F	1.40 REF.				
Е	5.70	5.80	5. 90		
е	1	. 27 BSC	•		
Н	5. 95	6.08	6. 20		
L1	0.10	0. 14	0. 18		
G	0	. 60 REF			
K	4	. 00 REF			

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